

FIG. 1 (PRIOR ART)

200



210

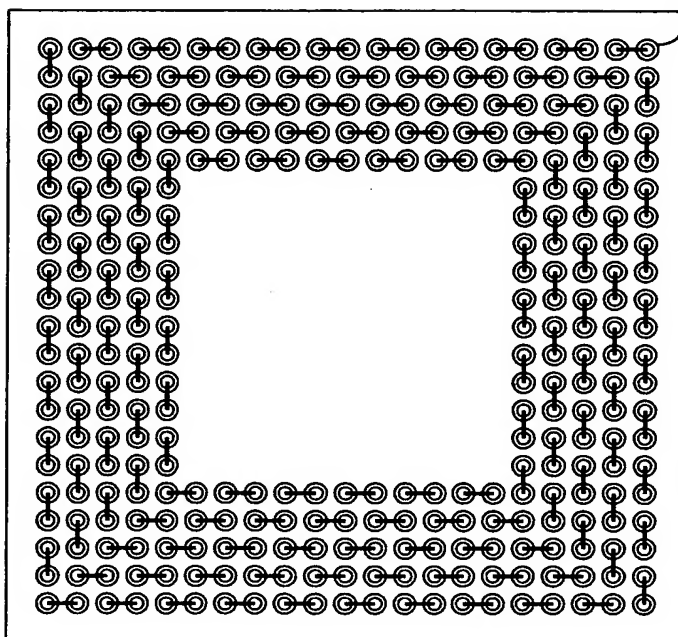


FIG. 2

# TEST ASSEMBLY FOR INTEGRATED CIRCUIT PACKAGE

Docket No. 4459-090A

Inventor: Po Jen CHENG *et al.*

Replacement Sheet of Drawing

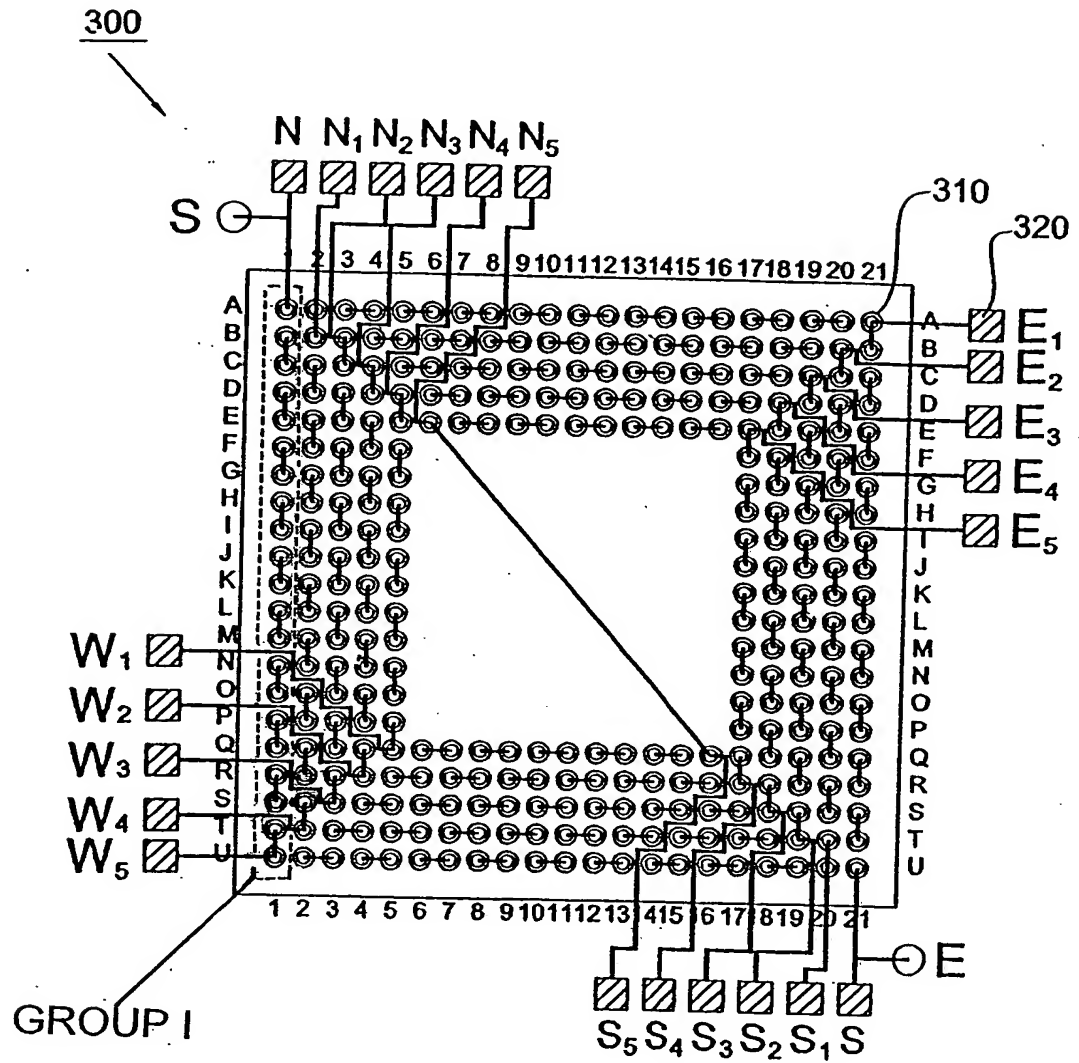


FIG. 3

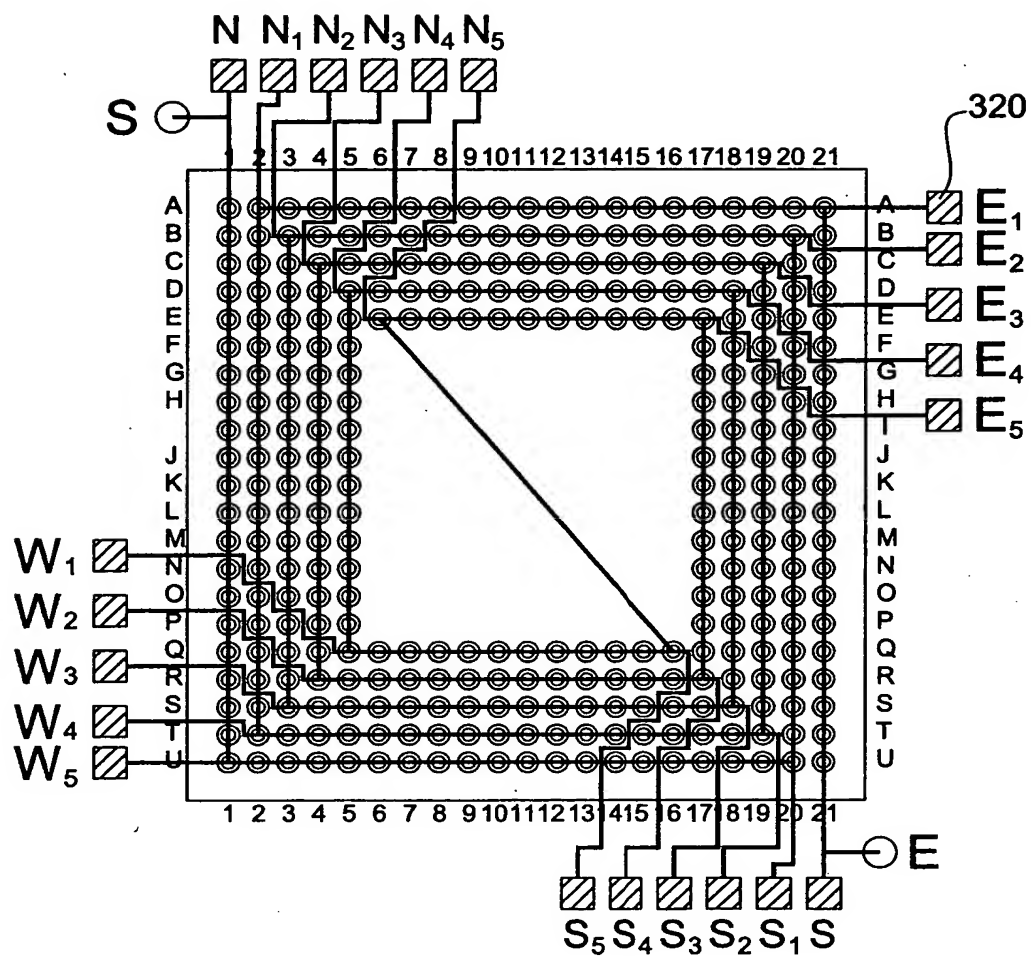


FIG. 4